

NOTE:

1. MATERIAL:
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, T=0.15MM
CAP: STAINLESS STEEL, T=0.1MM
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1.27um(50u") MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260°C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW.
5. PRODUCT NUMBERING:
20021323 - X 0 0 XX X X LF

LEAD FREE

PLATING:

1: GOLD FLASH ALL OVER
4: 0.25um(10U") GOLD AT CONTACT
8: 0.76um(30U") GOLD AT CONTACT
9: 1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

D: TUBE + CAP

T: TUBE

C: REEL + CAP (8, 10, 20, 22, 30, 40, 42, 70P)

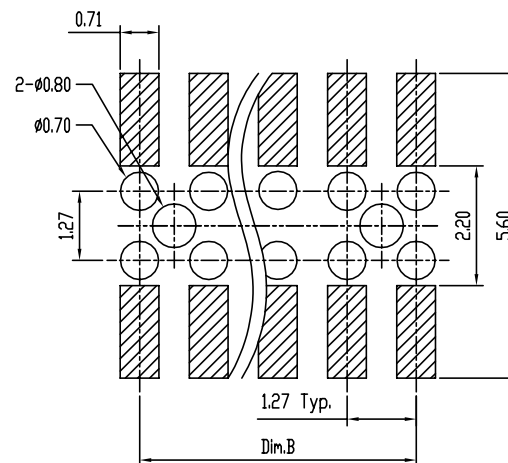
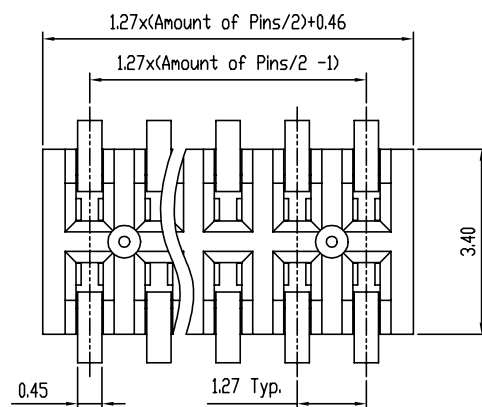
PIN COUNT

4, 6, 8, ..., 80

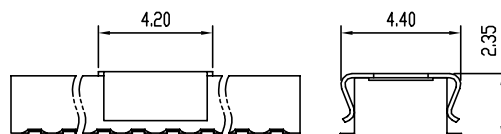
(EVERY EVEN PIN)

0: WITHOUT POST

1: WITH POST



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm



With Cap
Scale 4:1

mat'l. code			surface	tolerance	projection	product family		
ISO1302			ISO1101	ISO406		MINITEK		
l	tr	ec	n	odr	date	angle	scale	title
A	T09-1117	S	L	I	N	09/15/09	0.X±0.38	1.27X1.27MM BTB RECEPTACLE
B	T10-0020	S	L	I	N	01/20/10	0.XX±0.25	SMT BOTTOM ENTYR
C	T10-0120	S	L	I	N	07/30/10	0.XXX±0.10	scale 8:1
D	ELXT004402	S	L	I	N	07/11/11	dr	STERLING LIN 09/15/09
E	BX-N-010370	Z	K			01/18/12	eng	STERLING LIN 09/15/09
F	BX-N-011532	Z	K			05/07/12	chr	GRAY HSIEH 09/15/09
G	BX-N-011756	Z	K			05/28/12	appd	JOSEPH 09/15/09
sheet	revising							
index	sheet	1						
			dwg no	sheet	1 of 1	size		
			20021323			A4		
			type	Product	Customer	Drawing		